

## N-channel 600 V, 0.55 $\Omega$ typ., 7.5 A MDmesh™ M2 Power MOSFET in a TO-220FP package

Datasheet - production data

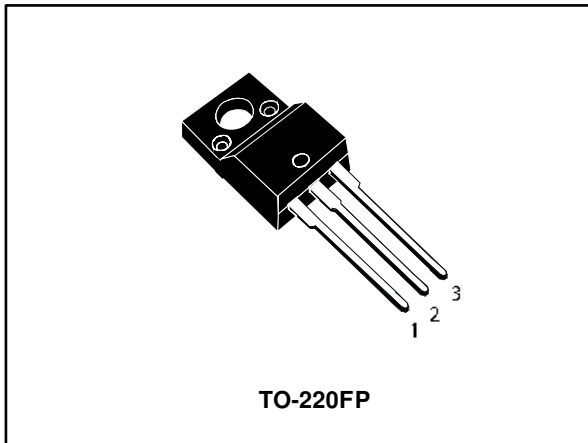
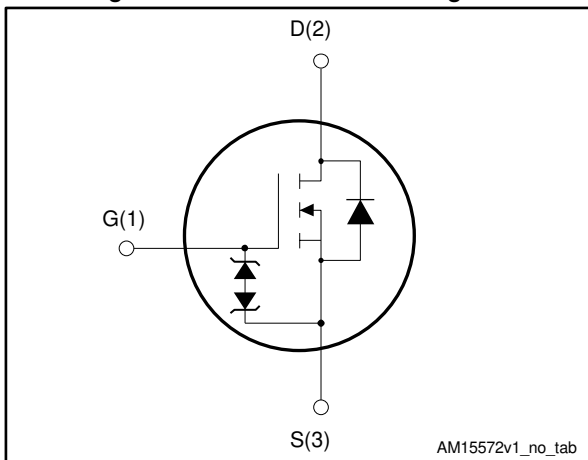


Figure 1: Internal schematic diagram



### Features

| Order code | V <sub>DS@T<sub>Jmax</sub></sub> | R <sub>DS(on) max.</sub> | I <sub>D</sub> |
|------------|----------------------------------|--------------------------|----------------|
| STF10N60M2 | 650 V                            | 0.60 $\Omega$            | 7.5 A          |

- Extremely low gate charge
- Excellent output capacitance (C<sub>oss</sub>) profile
- 100% avalanche tested
- Zener-protected

### Applications

- Switching applications

### Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

| Order code | Marking | Package  | Packing |
|------------|---------|----------|---------|
| STF10N60M2 | 10N60M2 | TO-220FP | Tube    |

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## Contents

|          |                                               |           |
|----------|-----------------------------------------------|-----------|
| <b>1</b> | <b>Electrical ratings .....</b>               | <b>3</b>  |
| <b>2</b> | <b>Electrical characteristics .....</b>       | <b>4</b>  |
|          | 2.2 Electrical characteristics (curves) ..... | 6         |
| <b>3</b> | <b>Test circuits .....</b>                    | <b>8</b>  |
| <b>4</b> | <b>Package information .....</b>              | <b>9</b>  |
|          | 4.1 TO-220FP package information .....        | 10        |
| <b>5</b> | <b>Revision history .....</b>                 | <b>12</b> |

# 1 Electrical ratings

**Table 2: Absolute maximum ratings**

| Symbol          | Parameter                                                                     | Value      | Unit |
|-----------------|-------------------------------------------------------------------------------|------------|------|
| $V_{GS}$        | Gate-source voltage                                                           | $\pm 25$   | V    |
| $I_D^{(1)}$     | Drain current (continuous) at $T_{case} = 25\text{ °C}$                       | 7.5        | A    |
|                 | Drain current (continuous) at $T_{case} = 100\text{ °C}$                      | 4.9        |      |
| $I_{DM}^{(2)}$  | Drain current (pulsed)                                                        | 30         | A    |
| $P_{TOT}$       | Total dissipation at $T_{case} = 25\text{ °C}$                                | 25         | W    |
| $dv/dt^{(3)}$   | Peak diode recovery voltage slope                                             | 15         | V/ns |
| $dv/dt^{(4)}$   | MOSFET $dv/dt$ ruggedness                                                     | 50         |      |
| $V_{ISO}^{(5)}$ | Insulation withstand voltage (RMS) from all three leads to external heat sink | 2500       | V    |
| $T_{stg}$       | Storage temperature range                                                     | -55 to 150 | °C   |
| $T_j$           | Operating junction temperature range                                          |            |      |

**Notes:**

(1) Limited by package.

(2) Pulse limited by safe operating area.

(3)  $I_{SD} \leq 7.5\text{ A}$ ,  $di/dt \leq 400\text{ A}/\mu\text{s}$ ;  $V_{DS\text{ peak}} < V_{(BR)DSS}$ ,  $V_{DD} = 400\text{ V}$

(4)  $V_{DS} \leq 480\text{ V}$ .

(5)  $t = 1\text{ s}$ ;  $T_C = 25\text{ °C}$ .

**Table 3: Thermal data**

| Symbol         | Parameter                           | Value | Unit |
|----------------|-------------------------------------|-------|------|
| $R_{thj-case}$ | Thermal resistance junction-case    | 5     | °C/W |
| $R_{thj-amb}$  | Thermal resistance junction-ambient | 62.5  |      |

**Table 4: Avalanche characteristics**

| Symbol         | Parameter                                       | Value | Unit |
|----------------|-------------------------------------------------|-------|------|
| $I_{AR}^{(1)}$ | Avalanche current, repetitive or not repetitive | 1.5   | A    |
| $E_{AS}^{(2)}$ | Single pulse avalanche energy                   | 110   | mJ   |

**Notes:**

(1) Pulse width limited by  $T_{jmax}$ .

(2) Starting  $T_j = 25\text{ °C}$ ,  $I_D = I_{AR}$ ,  $V_{DD} = 50\text{ V}$ .

## 2 Electrical characteristics

( $T_{\text{case}} = 25\text{ °C}$  unless otherwise specified)

**Table 5: Static**

| Symbol                      | Parameter                         | Test conditions                                                                                                     | Min. | Typ. | Max.     | Unit          |
|-----------------------------|-----------------------------------|---------------------------------------------------------------------------------------------------------------------|------|------|----------|---------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage    | $V_{\text{GS}} = 0\text{ V}$ , $I_{\text{D}} = 1\text{ mA}$                                                         | 600  |      |          | V             |
| $I_{\text{DSS}}$            | Zero gate voltage drain current   | $V_{\text{GS}} = 0\text{ V}$ , $V_{\text{DS}} = 600\text{ V}$                                                       |      |      | 1        | $\mu\text{A}$ |
|                             |                                   | $V_{\text{GS}} = 0\text{ V}$ , $V_{\text{DS}} = 600\text{ V}$ ,<br>$T_{\text{case}} = 125\text{ °C}$ <sup>(1)</sup> |      |      | 100      |               |
| $I_{\text{GSS}}$            | Gate-body leakage current         | $V_{\text{DS}} = 0\text{ V}$ , $V_{\text{GS}} = \pm 25\text{ V}$                                                    |      |      | $\pm 10$ | $\mu\text{A}$ |
| $V_{\text{GS(th)}}$         | Gate threshold voltage            | $V_{\text{DS}} = V_{\text{GS}}$ , $I_{\text{D}} = 250\text{ }\mu\text{A}$                                           | 2    | 3    | 4        | V             |
| $R_{\text{DS(on)}}$         | Static drain-source on-resistance | $V_{\text{GS}} = 10\text{ V}$ , $I_{\text{D}} = 3\text{ A}$                                                         |      | 0.55 | 0.60     | $\Omega$      |

**Notes:**

<sup>(1)</sup>Defined by design, not subject to production test.

**Table 6: Dynamic**

| Symbol                            | Parameter                     | Test conditions                                                                                                                                                                         | Min. | Typ. | Max. | Unit          |
|-----------------------------------|-------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|---------------|
| $C_{\text{iss}}$                  | Input capacitance             | $V_{\text{DS}} = 100\text{ V}$ , $f = 1\text{ MHz}$ ,<br>$V_{\text{GS}} = 0\text{ V}$                                                                                                   | -    | 400  | -    | $\mu\text{F}$ |
| $C_{\text{oss}}$                  | Output capacitance            |                                                                                                                                                                                         | -    | 22   | -    |               |
| $C_{\text{rss}}$                  | Reverse transfer capacitance  |                                                                                                                                                                                         | -    | 0.84 | -    |               |
| $C_{\text{oss eq.}}^{\text{(1)}}$ | Equivalent output capacitance | $V_{\text{DS}} = 0\text{ to }480\text{ V}$ , $V_{\text{GS}} = 0\text{ V}$                                                                                                               | -    | 83   | -    | $\mu\text{F}$ |
| $R_{\text{G}}$                    | Intrinsic gate resistance     | $f = 1\text{ MHz}$ , $I_{\text{D}} = 0\text{ A}$                                                                                                                                        | -    | 6.4  | -    | $\Omega$      |
| $Q_{\text{g}}$                    | Total gate charge             | $V_{\text{DD}} = 480\text{ V}$ , $I_{\text{D}} = 7.5\text{ A}$ ,<br>$V_{\text{GS}} = 0\text{ to }10\text{ V}$ (see <a href="#">Figure 15: "Test circuit for gate charge behavior"</a> ) | -    | 13.5 | -    | nC            |
| $Q_{\text{gs}}$                   | Gate-source charge            |                                                                                                                                                                                         | -    | 2.1  | -    |               |
| $Q_{\text{gd}}$                   | Gate-drain charge             |                                                                                                                                                                                         | -    | 7.2  | -    |               |

**Notes:**

<sup>(1)</sup>  $C_{\text{oss eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{\text{oss}}$  when  $V_{\text{DS}}$  increases from 0 to 80%  $V_{\text{DSS}}$ .

**Table 7: Switching times**

| Symbol              | Parameter           | Test conditions                                                                                                                                                                                                                                                                    | Min. | Typ. | Max. | Unit |
|---------------------|---------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $t_{\text{d(on)}}$  | Turn-on delay time  | $V_{\text{DD}} = 300\text{ V}$ , $I_{\text{D}} = 3.75\text{ A}$<br>$R_{\text{G}} = 4.7\text{ }\Omega$ , $V_{\text{GS}} = 10\text{ V}$ (see <a href="#">Figure 14: "Test circuit for resistive load switching times"</a> and <a href="#">Figure 19: "Switching time waveform"</a> ) | -    | 8.8  | -    | ns   |
| $t_{\text{r}}$      | Rise time           |                                                                                                                                                                                                                                                                                    | -    | 8    | -    |      |
| $t_{\text{d(off)}}$ | Turn-off delay time |                                                                                                                                                                                                                                                                                    | -    | 32.5 | -    |      |
| $t_{\text{f}}$      | Fall time           |                                                                                                                                                                                                                                                                                    | -    | 13.2 | -    |      |

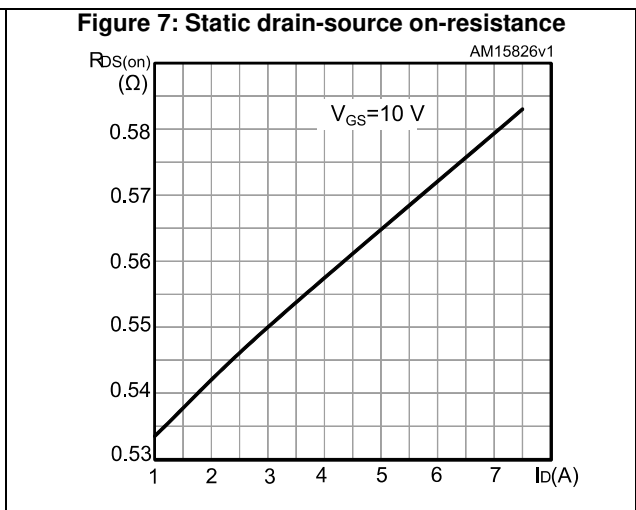
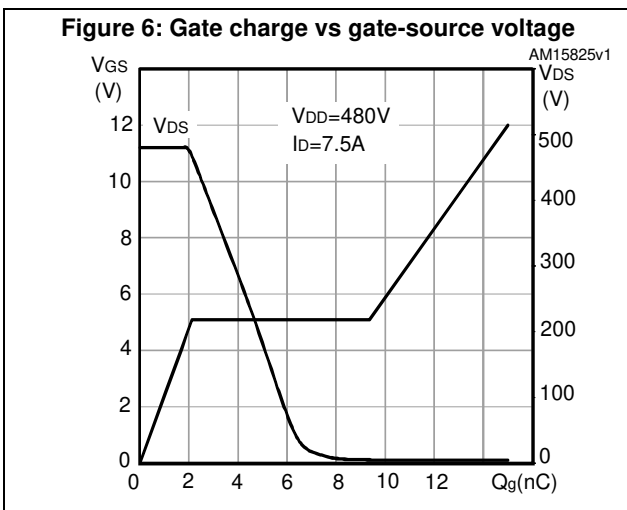
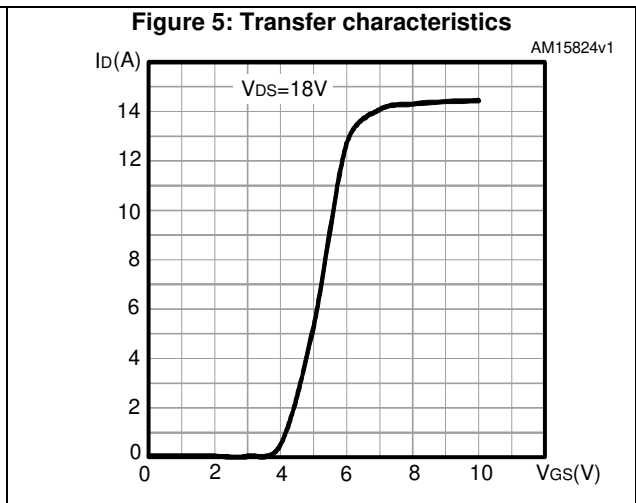
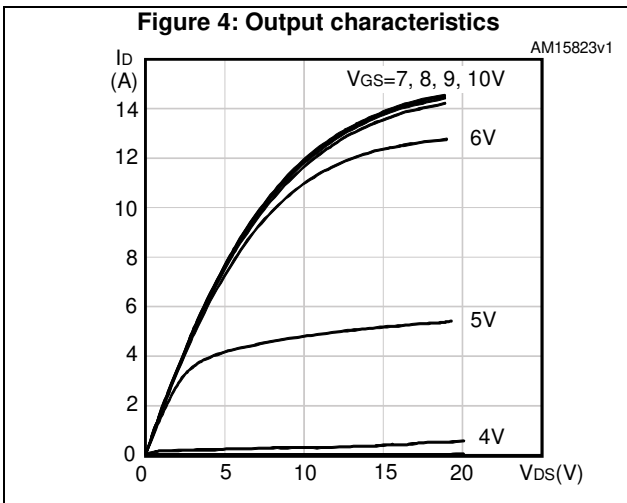
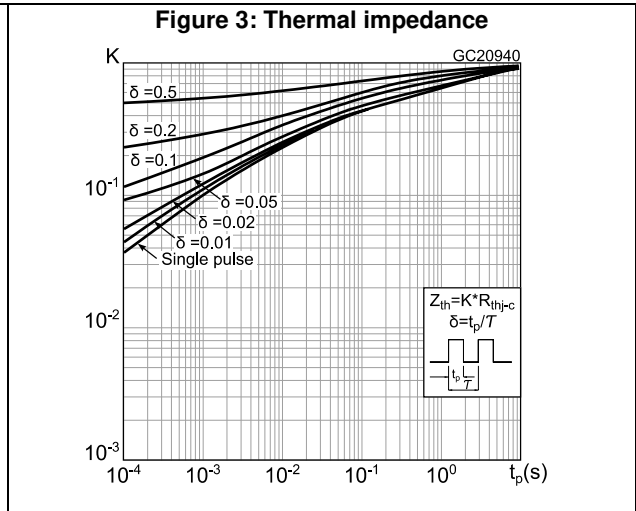
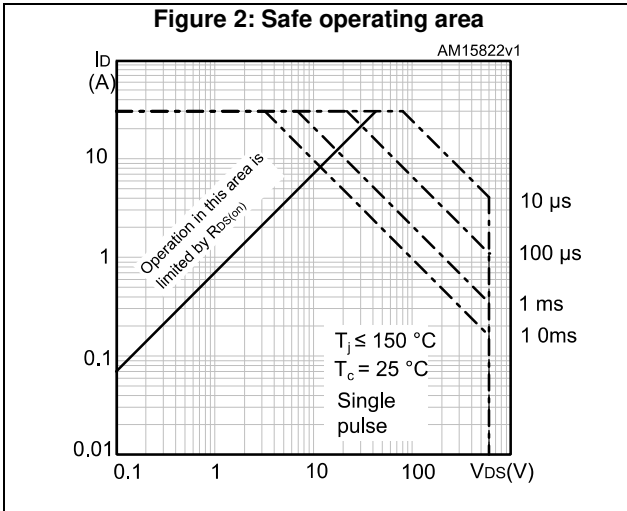
Table 8: Source-drain diode

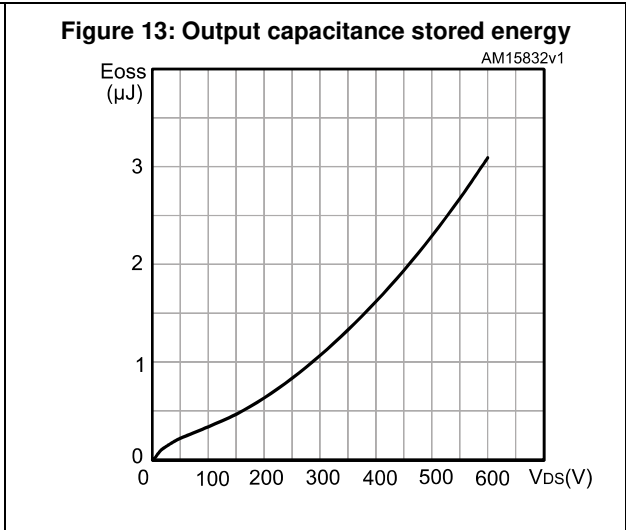
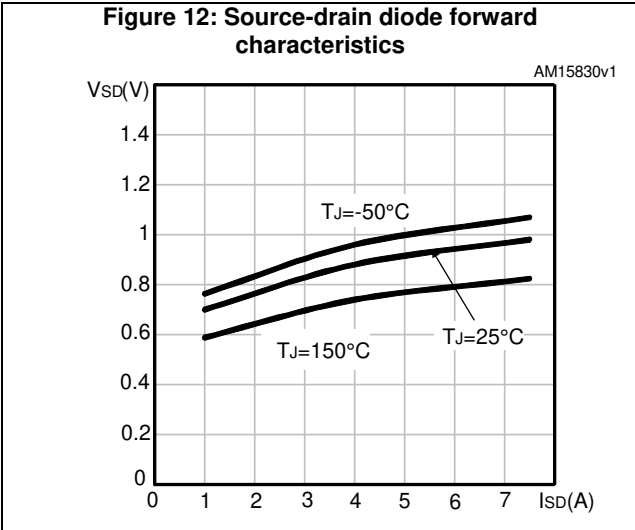
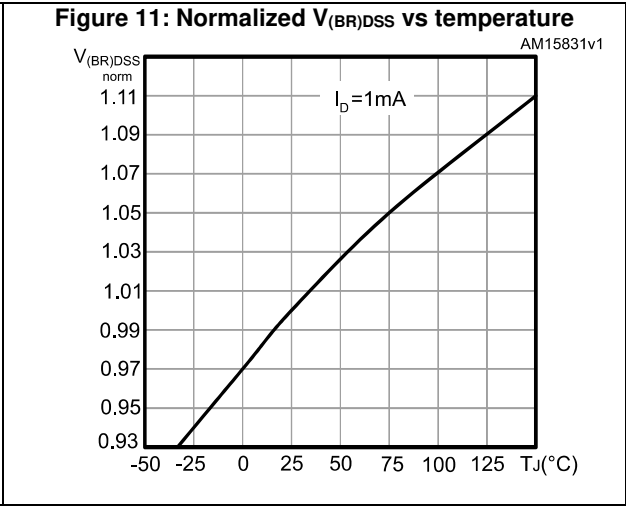
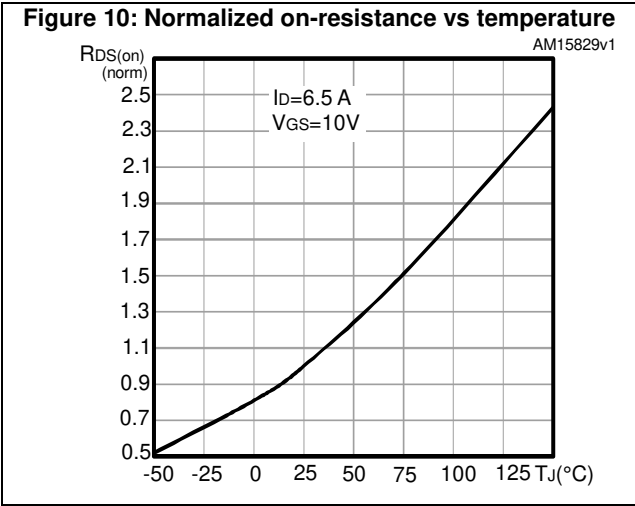
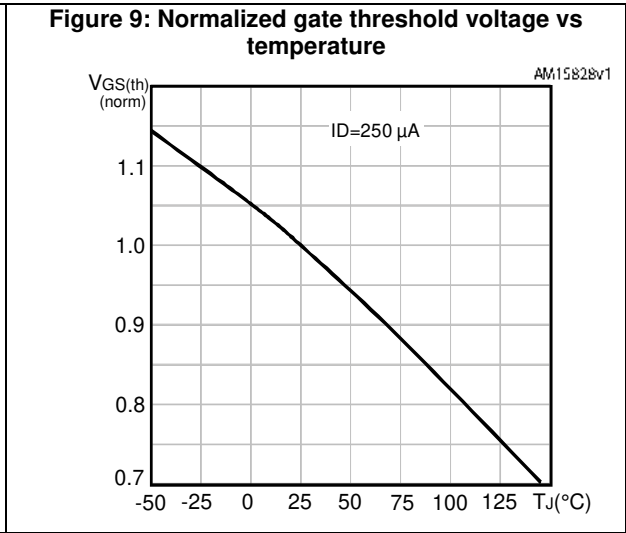
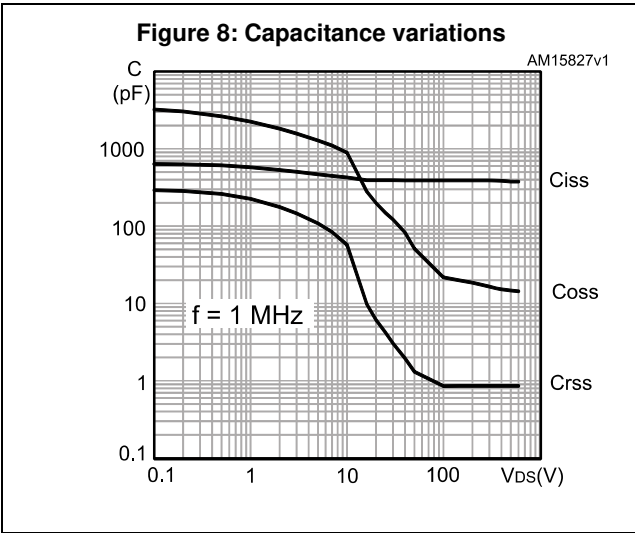
| Symbol          | Parameter                     | Test conditions                                                                                                                                                                                                                                  | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|---------------|
| $I_{SD}^{(1)}$  | Source-drain current          |                                                                                                                                                                                                                                                  | -    |      | 7.5  | A             |
| $I_{SDM}^{(2)}$ | Source-drain current (pulsed) |                                                                                                                                                                                                                                                  | -    |      | 30   | A             |
| $V_{SD}^{(3)}$  | Forward on voltage            | $V_{GS} = 0 \text{ V}$ , $I_{SD} = 7.5 \text{ A}$                                                                                                                                                                                                | -    |      | 1.6  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 7.5 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 60 \text{ V}$ (see <a href="#">Figure 16</a> :<br>"Test circuit for inductive load<br>switching and diode recovery<br>times")                                      | -    | 270  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                                                                                                  | -    | 2    |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                                                                                                  | -    | 14.4 |      | A             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 7.5 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$ ,<br>$V_{DD} = 60 \text{ V}$ , $T_j = 150 \text{ }^\circ\text{C}$ (see<br><a href="#">Figure 16</a> : "Test circuit for<br>inductive load switching and<br>diode recovery times") | -    | 376  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |                                                                                                                                                                                                                                                  | -    | 2.8  |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |                                                                                                                                                                                                                                                  | -    | 15   |      | A             |

**Notes:**

- (1) Limited by package.  
(2) Pulse width is limited by safe operating area.  
(3) Pulse test: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

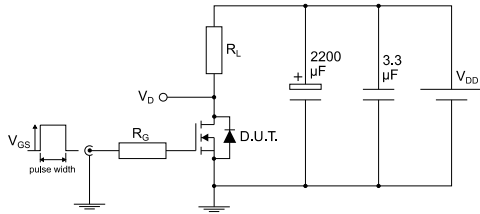
## 2.2 Electrical characteristics (curves)





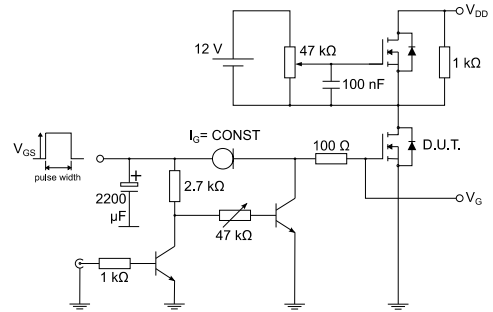
### 3 Test circuits

**Figure 14: Test circuit for resistive load switching times**



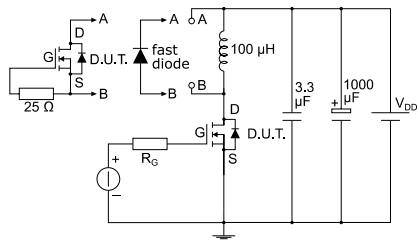
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**Figure 15: Test circuit for gate charge behavior**



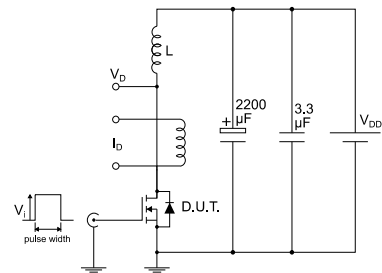
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**Figure 16: Test circuit for inductive load switching and diode recovery times**



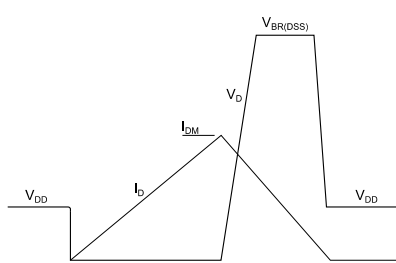
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**Figure 17: Unclamped inductive load test circuit**



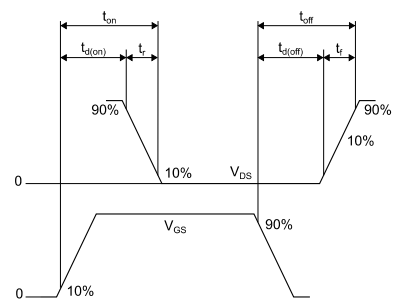
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**Figure 18: Unclamped inductive waveform**



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**Figure 19: Switching time waveform**



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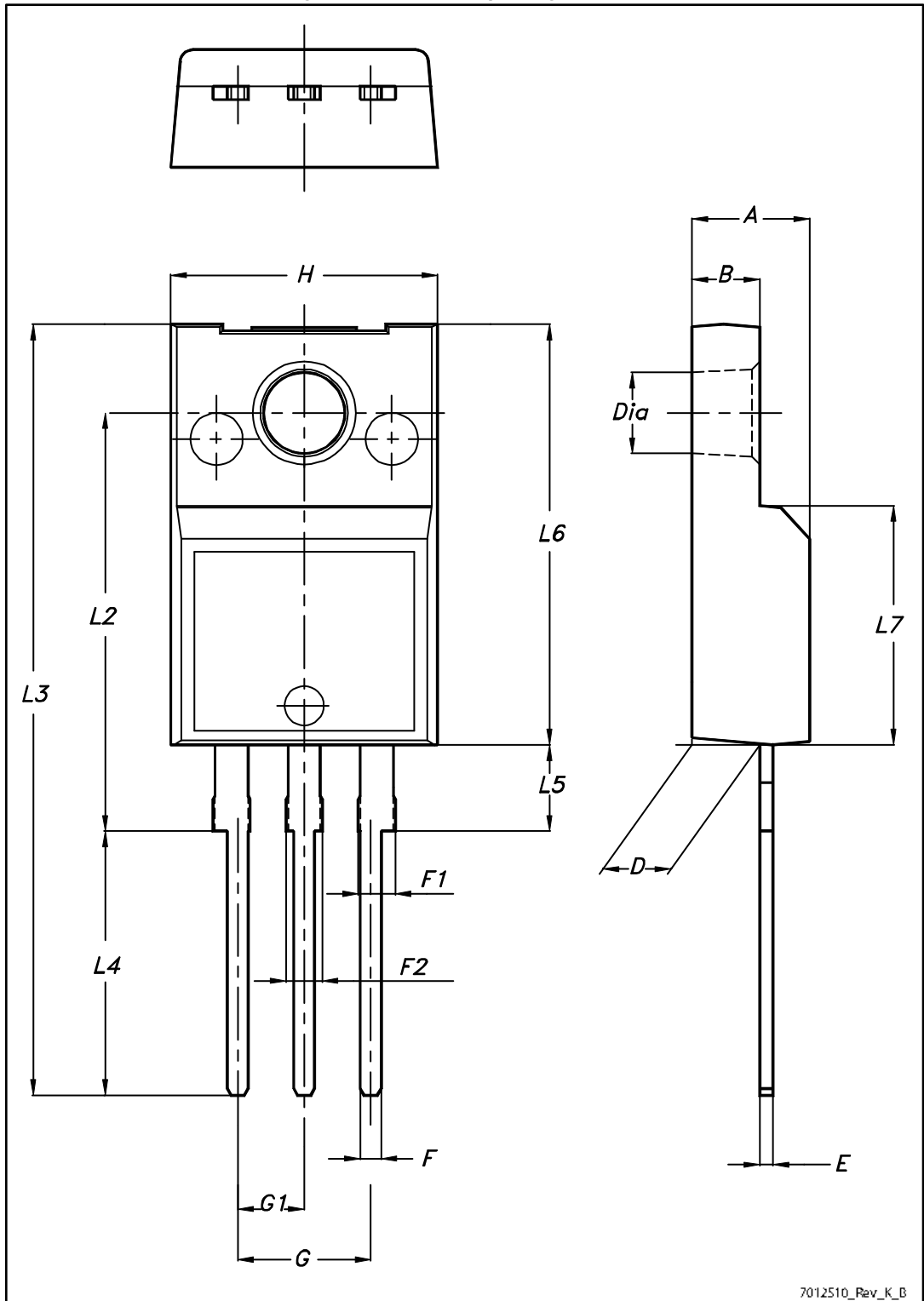


## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 4.1 TO-220FP package information

Figure 20: TO-220FP package outline



7012510\_Rev\_K\_B

Table 9: TO-220FP package mechanical data

| Dim. | mm   |      |      |
|------|------|------|------|
|      | Min. | Typ. | Max. |
| A    | 4.4  |      | 4.6  |
| B    | 2.5  |      | 2.7  |
| D    | 2.5  |      | 2.75 |
| E    | 0.45 |      | 0.7  |
| F    | 0.75 |      | 1    |
| F1   | 1.15 |      | 1.70 |
| F2   | 1.15 |      | 1.70 |
| G    | 4.95 |      | 5.2  |
| G1   | 2.4  |      | 2.7  |
| H    | 10   |      | 10.4 |
| L2   |      | 16   |      |
| L3   | 28.6 |      | 30.6 |
| L4   | 9.8  |      | 10.6 |
| L5   | 2.9  |      | 3.6  |
| L6   | 15.9 |      | 16.4 |
| L7   | 9    |      | 9.3  |
| Dia  | 3    |      | 3.2  |

## 5 Revision history

**Table 10: Document revision history**

| Date        | Revision | Changes                                                                                                                                                                                                                                                                                                          |
|-------------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 29-May-2013 | 1        | First release.                                                                                                                                                                                                                                                                                                   |
| 14-Oct-2013 | 2        | Modified: $R_G$ value in <i>Table 6</i><br>Minor text changes                                                                                                                                                                                                                                                    |
| 06-Dec-2013 | 3        | Added: I <sup>2</sup> PAKFP package<br>– Modified: title<br>– Modified: $R_{DS(on)}$ typical values in <i>Table 5</i><br>– Modified: $R_G$ value in <i>Table 6</i><br>– Modified: <i>Figure 7</i> and $I_D$ value in <i>Figure 10</i><br>– Added: <i>Table 10</i> , and <i>Figure 21</i><br>– Minor text changes |
| 09-Mar-2017 | 4        | The device in I <sup>2</sup> PAKFP has been removed and this document has been updated accordingly.<br>Updated the title and the description in cover page.<br>Updated <i>Table 4: "Avalanche characteristics"</i> .<br>Minor text changes.                                                                      |

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